

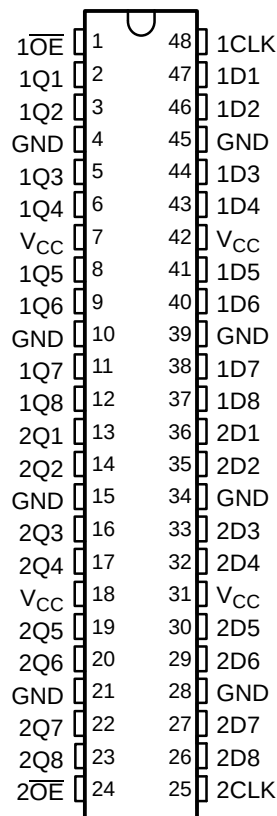
## FEATURES

- Member of the Texas Instruments Widebus™ Family
- Operates From 1.65 V to 3.6 V
- Inputs Accept Voltages to 5.5 V
- Max  $t_{pd}$  of 4.5 ns at 3.3 V
- Typical  $V_{OLP}$  (Output Ground Bounce) <0.8 V at  $V_{CC} = 3.3$  V,  $T_A = 25^\circ\text{C}$
- Typical  $V_{OHV}$  (Output  $V_{OH}$  Undershoot) >2 V at  $V_{CC} = 3.3$  V,  $T_A = 25^\circ\text{C}$
- $I_{off}$  Supports Partial-Power-Down Mode Operation
- Supports Mixed-Mode Signal Operation on All Ports (5-V Input and Output Voltages With 3.3-V  $V_{CC}$ )
- Bus Hold on Data Inputs Eliminates the Need for External Pullup/Pulldown Resistors
- Latch-Up Performance Exceeds 250 mA Per JESD 17
- ESD Protection Exceeds JESD 22
  - 2000-V Human-Body Model (A114-A)
  - 1000-V Charged-Device Model (C101)

## DESCRIPTION/ORDERING INFORMATION

This 16-bit edge-triggered D-type flip-flop is designed for 1.65-V to 3.6-V  $V_{CC}$  operation.

DGG, DGV, OR DL PACKAGE  
(TOP VIEW)



## ORDERING INFORMATION

| $T_A$         | PACKAGE <sup>(1)</sup> |               | ORDERABLE PART NUMBER | TOP-SIDE MARKING |
|---------------|------------------------|---------------|-----------------------|------------------|
| –40°C to 85°C | FBGA – GRD             | Tape and reel | SN74LVCH16374AGRDR    | LDH374A          |
|               | FBGA – ZRD (Pb-free)   |               | SN74LVCH16374AZRDR    |                  |
|               | SSOP – DL              | Tube          | SN74LVCH16374ADL      | LVCH16374A       |
|               |                        |               | 74LVCH16374ADLG4      |                  |
|               |                        | Tape and reel | SN74LVCH16374ADL      |                  |
|               |                        |               | 74LVCH16374ADLRG4     |                  |
|               | TSSOP – DGG            | Tape and reel | SN74LVCH16374ADGGR    | LVCH16374A       |
|               |                        |               | 74LVCH16374ADGGRG4    |                  |
|               | TVSOP – DGV            | Tape and reel | SN74LVCH16374ADGVR    | LDH374A          |
|               |                        |               | 74LVCH16374ADGVRE4    |                  |
|               | VFBGA – GQL            | Tape and reel | SN74LVCH16374AGQLR    | LDH374A          |
|               | VFBGA – ZQL (Pb-free)  |               | SN74LVCH16374AZQLR    |                  |

(1) Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at [www.ti.com/sc/package](http://www.ti.com/sc/package).



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

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# SN74LVCH16374A

## 16-BIT EDGE-TRIGGERED D-TYPE FLIP-FLOP WITH 3-STATE OUTPUTS

SCAS757A–DECEMBER 2003–REVISED OCTOBER 2005

### DESCRIPTION/ORDERING INFORMATION (CONTINUED)

A buffered output-enable ( $\overline{OE}$ ) input can be used to place the eight outputs in either a normal logic state (high or low logic levels) or the high-impedance state. In the high-impedance state, the outputs neither load nor drive the bus lines significantly. The high-impedance state and increased drive provide the capability to drive bus lines without interface or pullup components.

$\overline{OE}$  does not affect internal operations of the flip-flop. Old data can be retained or new data can be entered while the outputs are in the high-impedance state.

To ensure the high-impedance state during power up or power down,  $\overline{OE}$  should be tied to  $V_{CC}$  through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver.

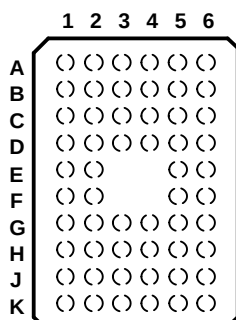
Inputs can be driven from either 3.3-V or 5-V devices. This feature allows the use of this device as a translator in a mixed 3.3-V/5-V system environment.

Active bus-hold circuitry holds unused or undriven inputs at a valid logic state. Use of pullup or pulldown resistors with the bus-hold circuitry is not recommended.

The SN74LVCH16374A is particularly suitable for implementing buffer registers, I/O ports, bidirectional bus drivers, and working registers. It can be used as two 8-bit flip-flops or one 16-bit flip-flop. On the positive transition of the clock (CLK) input, the Q outputs of the flip-flop take on the logic levels set up at the data (D) inputs.

This device is fully specified for partial-power-down applications using  $I_{off}$ . The  $I_{off}$  circuitry disables the outputs, preventing damaging current backflow through the device when it is powered down.

**GQL OR ZQL PACKAGE  
(TOP VIEW)**

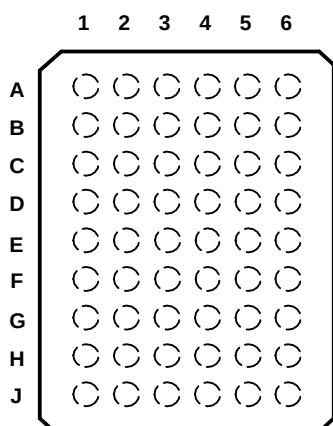


**TERMINAL ASSIGNMENTS<sup>(1)</sup>  
(56-Ball GQL/ZQL Package)**

|   | 1                 | 2   | 3        | 4        | 5   | 6    |
|---|-------------------|-----|----------|----------|-----|------|
| A | 1 $\overline{OE}$ | NC  | NC       | NC       | NC  | 1CLK |
| B | 1Q2               | 1Q1 | GND      | GND      | 1D1 | 1D2  |
| C | 1Q4               | 1Q3 | $V_{CC}$ | $V_{CC}$ | 1D3 | 1D4  |
| D | 1Q6               | 1Q5 | GND      | GND      | 1D5 | 1D6  |
| E | 1Q8               | 1Q7 |          |          | 1D7 | 1D8  |
| F | 2Q1               | 2Q2 |          |          | 2D2 | 2D1  |
| G | 2Q3               | 2Q4 | GND      | GND      | 2D4 | 2D3  |
| H | 2Q5               | 2Q6 | $V_{CC}$ | $V_{CC}$ | 2D6 | 2D5  |
| J | 2Q7               | 2Q8 | GND      | GND      | 2D8 | 2D7  |
| K | 2 $\overline{OE}$ | NC  | NC       | NC       | NC  | 2CLK |

(1) NC – No internal connection

**GRD OR ZRD PACKAGE  
(TOP VIEW)**



**TERMINAL ASSIGNMENTS<sup>(1)</sup>  
(54-Ball GRD/ZRD Package)**

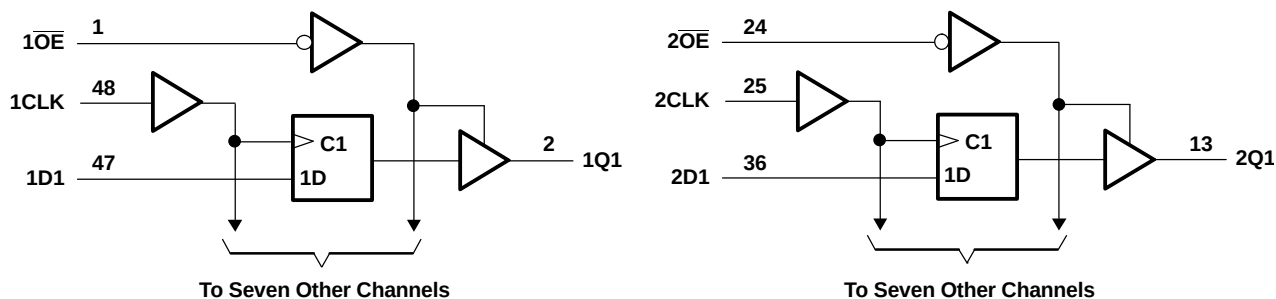
|   | 1   | 2   | 3                 | 4        | 5   | 6   |
|---|-----|-----|-------------------|----------|-----|-----|
| A | 1Q1 | NC  | 1 $\overline{OE}$ | 1CLK     | NC  | 1D1 |
| B | 1Q3 | 1Q2 | NC                | NC       | 1D2 | 1D3 |
| C | 1Q5 | 1Q4 | $V_{CC}$          | $V_{CC}$ | 1D4 | 1D5 |
| D | 1Q7 | 1Q6 | GND               | GND      | 1D6 | 1D7 |
| E | 2Q1 | 1Q8 | GND               | GND      | 1D8 | 2D1 |
| F | 2Q3 | 2Q2 | GND               | GND      | 2D2 | 2D3 |
| G | 2Q5 | 2Q4 | $V_{CC}$          | $V_{CC}$ | 2D4 | 2D5 |
| H | 2Q7 | 2Q6 | NC                | NC       | 2D6 | 2D7 |
| J | 2Q8 | NC  | 2 $\overline{OE}$ | 2CLK     | NC  | 2D8 |

(1) NC – No internal connection

**FUNCTION TABLE  
(EACH FLIP-FLOP)**

| INPUTS          |        |   | OUTPUT<br>Q |
|-----------------|--------|---|-------------|
| $\overline{OE}$ | CLK    | D |             |
| L               | ↑      | H | H           |
| L               | ↑      | L | L           |
| L               | H or L | X | $Q_0$       |
| H               | X      | X | Z           |

**LOGIC DIAGRAM (POSITIVE LOGIC)**



Pin numbers shown are for the DGG, DGV, and DL packages.

## Absolute Maximum Ratings<sup>(1)</sup>

over operating free-air temperature range (unless otherwise noted)

|               |                                                                                             | MIN             | MAX            | UNIT |
|---------------|---------------------------------------------------------------------------------------------|-----------------|----------------|------|
| $V_{CC}$      | Supply voltage range                                                                        | −0.5            | 6.5            | V    |
| $V_I$         | Input voltage range <sup>(2)</sup>                                                          | −0.5            | 6.5            | V    |
| $V_O$         | Voltage range applied to any output in the high-impedance or power-off state <sup>(2)</sup> | −0.5            | 6.5            | V    |
| $V_O$         | Voltage range applied to any output in the high or low state <sup>(2) (3)</sup>             | −0.5            | $V_{CC} + 0.5$ | V    |
| $I_{IK}$      | Input clamp current                                                                         | $V_I < 0$       | −50            | mA   |
| $I_{OK}$      | Output clamp current                                                                        | $V_O < 0$       | −50            | mA   |
| $I_O$         | Continuous output current                                                                   |                 | ±50            | mA   |
|               | Continuous current through each $V_{CC}$ or GND                                             |                 | ±100           | mA   |
| $\theta_{JA}$ | Package thermal impedance <sup>(4)</sup>                                                    | DGG package     | 70             | °C/W |
|               |                                                                                             | DGV package     | 58             |      |
|               |                                                                                             | DL package      | 63             |      |
|               |                                                                                             | GQL/ZQL package | 42             |      |
|               |                                                                                             | GRD/ZRD package | 36             |      |
| $T_{stg}$     | Storage temperature range                                                                   | −65             | 150            | °C   |

- (1) Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.
- (2) The input negative-voltage and output voltage ratings may be exceeded if the input and output current ratings are observed.
- (3) The value of  $V_{CC}$  is provided in the recommended operating conditions table.
- (4) The package thermal impedance is calculated in accordance with JESD 51-7.

# SN74LVCH16374A

## 16-BIT EDGE-TRIGGERED D-TYPE FLIP-FLOP WITH 3-STATE OUTPUTS

SCAS757A–DECEMBER 2003–REVISED OCTOBER 2005



### Recommended Operating Conditions<sup>(1)</sup>

|                 |                                    |                                    | MIN                    | MAX                    | UNIT |
|-----------------|------------------------------------|------------------------------------|------------------------|------------------------|------|
| V <sub>CC</sub> | Supply voltage                     | Operating                          | 1.65                   | 3.6                    | V    |
|                 |                                    | Data retention only                | 1.5                    |                        |      |
| V <sub>IH</sub> | High-level input voltage           | V <sub>CC</sub> = 1.65 V to 1.95 V | 0.65 × V <sub>CC</sub> |                        | V    |
|                 |                                    | V <sub>CC</sub> = 2.3 V to 2.7 V   | 1.7                    |                        |      |
|                 |                                    | V <sub>CC</sub> = 2.7 V to 3.6 V   | 2                      |                        |      |
| V <sub>IL</sub> | Low-level input voltage            | V <sub>CC</sub> = 1.65 V to 1.95 V |                        | 0.35 × V <sub>CC</sub> | V    |
|                 |                                    | V <sub>CC</sub> = 2.3 V to 2.7 V   |                        | 0.7                    |      |
|                 |                                    | V <sub>CC</sub> = 2.7 V to 3.6 V   |                        | 0.8                    |      |
| V <sub>I</sub>  | Input voltage                      |                                    | 0                      | 5.5                    | V    |
| V <sub>O</sub>  | Output voltage                     | High or low state                  | 0                      | V <sub>CC</sub>        | V    |
|                 |                                    | High-impedance state               | 0                      | 5.5                    |      |
| I <sub>OH</sub> | High-level output current          | V <sub>CC</sub> = 1.65 V           |                        | –4                     | mA   |
|                 |                                    | V <sub>CC</sub> = 2.3 V            |                        | –8                     |      |
|                 |                                    | V <sub>CC</sub> = 2.7 V            |                        | –12                    |      |
|                 |                                    | V <sub>CC</sub> = 3 V              |                        | –24                    |      |
| I <sub>OL</sub> | Low-level output current           | V <sub>CC</sub> = 1.65 V           |                        | 4                      | mA   |
|                 |                                    | V <sub>CC</sub> = 2.3 V            |                        | 8                      |      |
|                 |                                    | V <sub>CC</sub> = 2.7 V            |                        | 12                     |      |
|                 |                                    | V <sub>CC</sub> = 3 V              |                        | 24                     |      |
| Δt/Δv           | Input transition rise or fall rate |                                    |                        | 10                     | ns/V |
| T <sub>A</sub>  | Operating free-air temperature     |                                    | –40                    | 85                     | °C   |

- (1) All unused control inputs of the device must be held at V<sub>CC</sub> or GND to ensure proper device operation. Refer to the TI application report, *Implications of Slow or Floating CMOS Inputs*, literature number SCBA004.

## Electrical Characteristics

over recommended operating free-air temperature range (unless otherwise noted)

| PARAMETER            | TEST CONDITIONS                                                              | V <sub>CC</sub> | MIN                   | TYP <sup>(1)</sup> | MAX  | UNIT |
|----------------------|------------------------------------------------------------------------------|-----------------|-----------------------|--------------------|------|------|
| V <sub>OH</sub>      | I <sub>OH</sub> = –100 µA                                                    | 1.65 V to 3.6 V | V <sub>CC</sub> – 0.2 |                    |      | V    |
|                      | I <sub>OH</sub> = –4 mA                                                      | 1.65 V          | 1.2                   |                    |      |      |
|                      | I <sub>OH</sub> = –8 mA                                                      | 2.3 V           | 1.7                   |                    |      |      |
|                      | I <sub>OH</sub> = –12 mA                                                     | 2.7 V           | 2.2                   |                    |      |      |
|                      |                                                                              | 3 V             | 2.4                   |                    |      |      |
|                      | I <sub>OH</sub> = –24 mA                                                     | 3 V             | 2.2                   |                    |      |      |
| V <sub>OL</sub>      | I <sub>OL</sub> = 100 µA                                                     | 1.65 V to 3.6 V | 0.2                   |                    |      | V    |
|                      | I <sub>OL</sub> = 4 mA                                                       | 1.65 V          | 0.45                  |                    |      |      |
|                      | I <sub>OL</sub> = 8 mA                                                       | 2.3 V           | 0.7                   |                    |      |      |
|                      | I <sub>OL</sub> = 12 mA                                                      | 2.7 V           | 0.4                   |                    |      |      |
|                      | I <sub>OL</sub> = 24 mA                                                      | 3 V             | 0.55                  |                    |      |      |
| I <sub>I</sub>       | V <sub>I</sub> = 0 to 5.5 V                                                  | 3.6 V           |                       |                    | ±5   | µA   |
| I <sub>I(hold)</sub> | V <sub>I</sub> = 0.58 V                                                      | 1.65 V          | (2)                   |                    |      | µA   |
|                      | V <sub>I</sub> = 1.07 V                                                      |                 | (2)                   |                    |      |      |
|                      | V <sub>I</sub> = 0.7 V                                                       | 2.3 V           | 45                    |                    |      |      |
|                      | V <sub>I</sub> = 1.7 V                                                       |                 | –45                   |                    |      |      |
|                      | V <sub>I</sub> = 0.8 V                                                       | 3 V             | 75                    |                    |      |      |
|                      | V <sub>I</sub> = 2 V                                                         |                 | –75                   |                    |      |      |
|                      | V <sub>I</sub> = 0 to 3.6 V <sup>(3)</sup>                                   | 3.6 V           |                       |                    | ±500 |      |
| I <sub>off</sub>     | V <sub>I</sub> or V <sub>O</sub> = 5.5 V                                     | 0               |                       |                    | ±10  | µA   |
| I <sub>OZ</sub>      | V <sub>O</sub> = 0 to 5.5 V                                                  | 3.6 V           |                       |                    | ±10  | µA   |
| I <sub>CC</sub>      | V <sub>I</sub> = V <sub>CC</sub> or GND                                      | 3.6 V           |                       |                    | 20   | µA   |
|                      | 3.6 V ≤ V <sub>I</sub> ≤ 5.5 V <sup>(4)</sup>                                |                 |                       |                    | 20   |      |
| ΔI <sub>CC</sub>     | One input at V <sub>CC</sub> – 0.6 V, Other inputs at V <sub>CC</sub> or GND | 2.7 V to 3.6 V  |                       |                    | 500  | µA   |
| C <sub>i</sub>       | V <sub>I</sub> = V <sub>CC</sub> or GND                                      | 3.3 V           |                       |                    | 5    | pF   |
| C <sub>o</sub>       | V <sub>O</sub> = V <sub>CC</sub> or GND                                      | 3.3 V           |                       |                    | 6.5  | pF   |

(1) All typical values are at V<sub>CC</sub> = 3.3 V, T<sub>A</sub> = 25°C.

(2) This information was not available at the time of publication.

(3) This is the bus-hold maximum dynamic current required to switch the input from one state to another.

(4) This applies in the disabled state only.

## Timing Requirements

over recommended operating free-air temperature range (unless otherwise noted) (see [Figure 1](#))

|                    |                                 | V <sub>CC</sub> = 1.8 V<br>± 0.15 V |     | V <sub>CC</sub> = 2.5 V<br>± 0.2 V |     | V <sub>CC</sub> = 2.7 V |     | V <sub>CC</sub> = 3.3 V<br>± 0.3 V |     | UNIT |
|--------------------|---------------------------------|-------------------------------------|-----|------------------------------------|-----|-------------------------|-----|------------------------------------|-----|------|
|                    |                                 | MIN                                 | MAX | MIN                                | MAX | MIN                     | MAX | MIN                                | MAX |      |
| f <sub>clock</sub> | Clock frequency                 | (1)                                 |     | (1)                                |     | 150                     |     | 150                                |     | MHz  |
| t <sub>w</sub>     | Pulse duration, CLK high or low | (1)                                 |     | (1)                                |     | 3.3                     |     | 3.3                                |     | ns   |
| t <sub>SU</sub>    | Setup time, data before CLK↑    | (1)                                 |     | (1)                                |     | 1.9                     |     | 1.9                                |     | ns   |
| t <sub>h</sub>     | Hold time, data after CLK↑      | (1)                                 |     | (1)                                |     | 1.1                     |     | 1.1                                |     | ns   |

(1) This information was not available at the time of publication.

# SN74LVCH16374A

## 16-BIT EDGE-TRIGGERED D-TYPE FLIP-FLOP WITH 3-STATE OUTPUTS

SCAS757A–DECEMBER 2003–REVISED OCTOBER 2005

### Switching Characteristics

over recommended operating free-air temperature range (unless otherwise noted) (see [Figure 1](#))

| PARAMETER   | FROM<br>(INPUT) | TO<br>(OUTPUT) | $V_{CC} = 1.8\text{ V} \pm 0.15\text{ V}$ |     | $V_{CC} = 2.5\text{ V} \pm 0.2\text{ V}$ |     | $V_{CC} = 2.7\text{ V}$ |     | $V_{CC} = 3.3\text{ V} \pm 0.3\text{ V}$ |     | UNIT |
|-------------|-----------------|----------------|-------------------------------------------|-----|------------------------------------------|-----|-------------------------|-----|------------------------------------------|-----|------|
|             |                 |                | MIN                                       | MAX | MIN                                      | MAX | MIN                     | MAX | MIN                                      | MAX |      |
| $f_{\max}$  |                 |                | (1)                                       |     | (1)                                      |     | 150                     |     | 150                                      |     | MHz  |
| $t_{pd}$    | CLK             | Q              | (1)                                       | (1) | (1)                                      | (1) | 4.9                     |     | 1.5                                      | 4.5 | ns   |
| $t_{en}$    | $\overline{OE}$ | Q              | (1)                                       | (1) | (1)                                      | (1) | 5.3                     |     | 1.5                                      | 4.6 | ns   |
| $t_{dis}$   | $\overline{OE}$ | Q              | (1)                                       | (1) | (1)                                      | (1) | 6.1                     |     | 1.5                                      | 5.5 | ns   |
| $t_{sk(o)}$ |                 |                |                                           |     |                                          |     |                         |     | 1                                        |     | ns   |

(1) This information was not available at the time of publication.

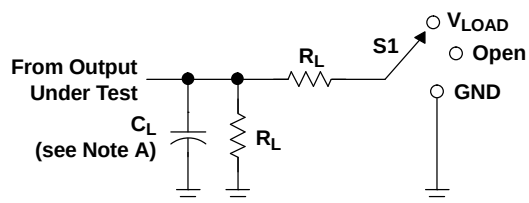
### Operating Characteristics

$T_A = 25^\circ\text{C}$

| PARAMETER |                                                |                  | TEST<br>CONDITIONS  | $V_{CC} = 1.8\text{ V}$ | $V_{CC} = 2.5\text{ V}$ | $V_{CC} = 3.3\text{ V}$ | UNIT |
|-----------|------------------------------------------------|------------------|---------------------|-------------------------|-------------------------|-------------------------|------|
|           |                                                |                  |                     | TYP                     | TYP                     | TYP                     |      |
| $C_{pd}$  | Power dissipation capacitance<br>per flip-flop | Outputs enabled  | $f = 10\text{ MHz}$ | (1)                     | (1)                     | 58                      | pF   |
|           |                                                | Outputs disabled |                     | (1)                     | (1)                     | 24                      |      |

(1) This information was not available at the time of publication.

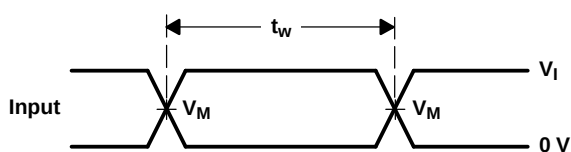
## PARAMETER MEASUREMENT INFORMATION



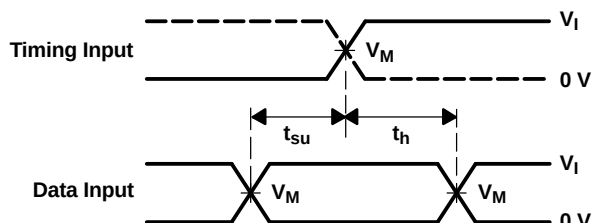
LOAD CIRCUIT

| TEST              | S1         |
|-------------------|------------|
| $t_{PLH}/t_{PHL}$ | Open       |
| $t_{PLZ}/t_{PZL}$ | $V_{LOAD}$ |
| $t_{PHZ}/t_{PZH}$ | GND        |

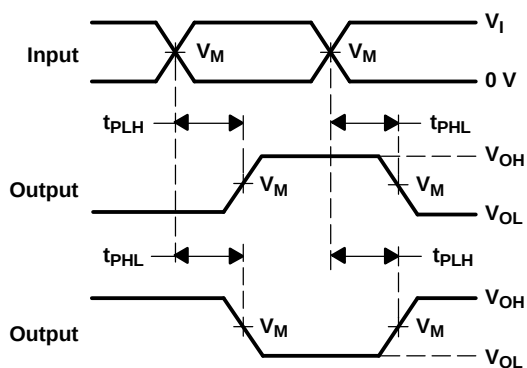
| $V_{CC}$                         | INPUTS   |                      | $V_M$      | $V_{LOAD}$        | $C_L$ | $R_L$        | $V_{\Delta}$ |
|----------------------------------|----------|----------------------|------------|-------------------|-------|--------------|--------------|
|                                  | $V_I$    | $t_r/t_f$            |            |                   |       |              |              |
| $1.8\text{ V} \pm 0.15\text{ V}$ | $V_{CC}$ | $\leq 2\text{ ns}$   | $V_{CC}/2$ | $2 \times V_{CC}$ | 30 pF | 1 k $\Omega$ | 0.15 V       |
| $2.5\text{ V} \pm 0.2\text{ V}$  | $V_{CC}$ | $\leq 2\text{ ns}$   | $V_{CC}/2$ | $2 \times V_{CC}$ | 30 pF | 500 $\Omega$ | 0.15 V       |
| 2.7 V                            | 2.7 V    | $\leq 2.5\text{ ns}$ | 1.5 V      | 6 V               | 50 pF | 500 $\Omega$ | 0.3 V        |
| $3.3\text{ V} \pm 0.3\text{ V}$  | 2.7 V    | $\leq 2.5\text{ ns}$ | 1.5 V      | 6 V               | 50 pF | 500 $\Omega$ | 0.3 V        |



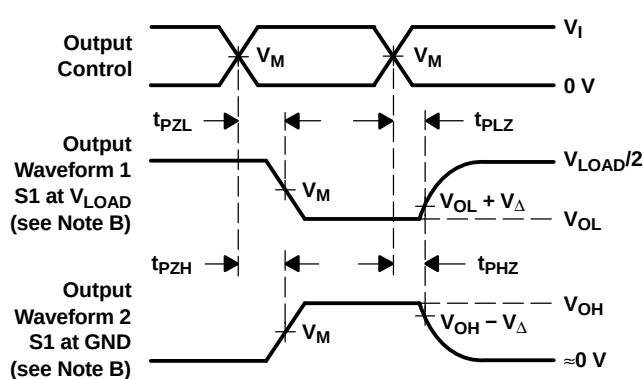
VOLTAGE WAVEFORMS  
PULSE DURATION



VOLTAGE WAVEFORMS  
SETUP AND HOLD TIMES



VOLTAGE WAVEFORMS  
PROPAGATION DELAY TIMES  
INVERTING AND NONINVERTING OUTPUTS



VOLTAGE WAVEFORMS  
ENABLE AND DISABLE TIMES  
LOW- AND HIGH-LEVEL ENABLING

- NOTES:
- $C_L$  includes probe and jig capacitance.
  - Waveform 1 is for an output with internal conditions such that the output is low, except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high, except when disabled by the output control.
  - All input pulses are supplied by generators having the following characteristics:  $PRR \leq 10\text{ MHz}$ ,  $Z_O = 50\ \Omega$ .
  - The outputs are measured one at a time, with one transition per measurement.
  - $t_{PLZ}$  and  $t_{PHZ}$  are the same as  $t_{dis}$ .
  - $t_{PZL}$  and  $t_{PZH}$  are the same as  $t_{en}$ .
  - $t_{PLH}$  and  $t_{PHL}$  are the same as  $t_{pd}$ .
  - All parameters and waveforms are not applicable to all devices.

Figure 1. Load Circuit and Voltage Waveforms

**PACKAGING INFORMATION**

| Orderable Device   | Status<br>(1) | Package Type               | Package<br>Drawing | Pins | Package Qty | Eco Plan<br>(2)            | Lead/Ball Finish | MSL Peak Temp<br>(3) | Samples<br>(Requires Login) |
|--------------------|---------------|----------------------------|--------------------|------|-------------|----------------------------|------------------|----------------------|-----------------------------|
| 74LVCH16374ADGGRG4 | ACTIVE        | TSSOP                      | DGG                | 48   | 2000        | Green (RoHS<br>& no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM   |                             |
| 74LVCH16374ADGVRE4 | ACTIVE        | TVSOP                      | DGV                | 48   | 2000        | Green (RoHS<br>& no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM   |                             |
| 74LVCH16374ADGVRG4 | ACTIVE        | TVSOP                      | DGV                | 48   | 2000        | Green (RoHS<br>& no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM   |                             |
| 74LVCH16374ADLG4   | ACTIVE        | SSOP                       | DL                 | 48   | 25          | Green (RoHS<br>& no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM   |                             |
| 74LVCH16374ADLRG4  | ACTIVE        | SSOP                       | DL                 | 48   | 1000        | Green (RoHS<br>& no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM   |                             |
| SN74LVCH16374ADGGR | ACTIVE        | TSSOP                      | DGG                | 48   | 2000        | Green (RoHS<br>& no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM   |                             |
| SN74LVCH16374ADGVR | ACTIVE        | TVSOP                      | DGV                | 48   | 2000        | Green (RoHS<br>& no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM   |                             |
| SN74LVCH16374ADL   | ACTIVE        | SSOP                       | DL                 | 48   | 25          | Green (RoHS<br>& no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM   |                             |
| SN74LVCH16374ADLR  | ACTIVE        | SSOP                       | DL                 | 48   | 1000        | Green (RoHS<br>& no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM   |                             |
| SN74LVCH16374AGQLR | OBSOLETE      | BGA<br>MICROSTAR<br>JUNIOR | GQL                | 56   |             | TBD                        | Call TI          | Call TI              |                             |
| SN74LVCH16374AZQLR | ACTIVE        | BGA<br>MICROSTAR<br>JUNIOR | ZQL                | 56   | 1000        | Green (RoHS<br>& no Sb/Br) | SNAGCU           | Level-1-260C-UNLIM   |                             |

(1) The marketing status values are defined as follows:

**ACTIVE:** Product device recommended for new designs.

**LIFEBUY:** TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

**NRND:** Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

**PREVIEW:** Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check <http://www.ti.com/productcontent> for the latest availability information and additional product content details.

**TBD:** The Pb-Free/Green conversion plan has not been defined.



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**Pb-Free (RoHS):** TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

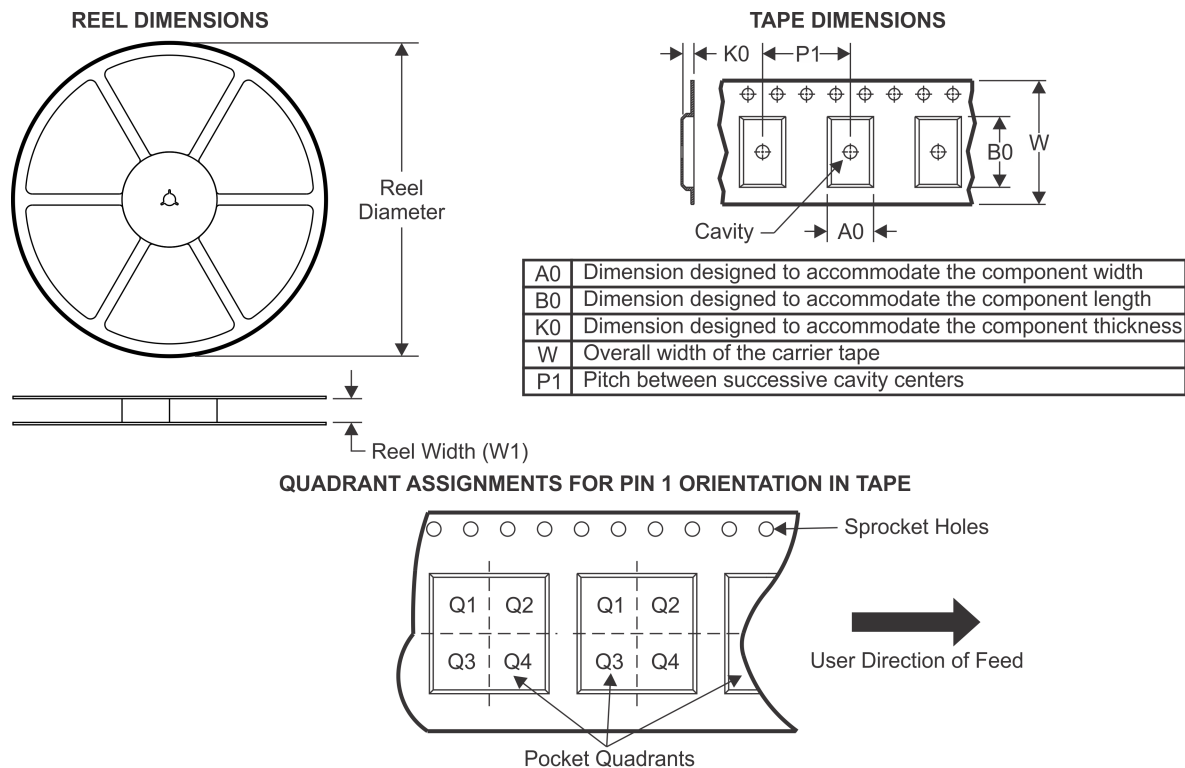
**Pb-Free (RoHS Exempt):** This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

**Green (RoHS & no Sb/Br):** TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

<sup>(3)</sup> MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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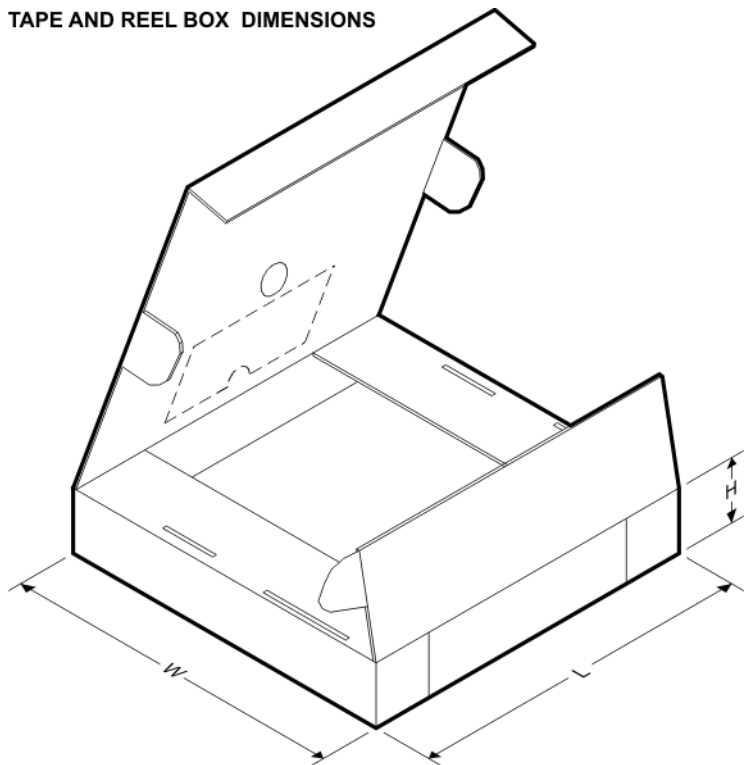
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**TAPE AND REEL INFORMATION**


\*All dimensions are nominal

| Device             | Package Type         | Package Drawing | Pins | SPQ  | Reel Diameter (mm) | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1 (mm) | W (mm) | Pin1 Quadrant |
|--------------------|----------------------|-----------------|------|------|--------------------|--------------------|---------|---------|---------|---------|--------|---------------|
| SN74LVCH16374ADGGR | TSSOP                | DGG             | 48   | 2000 | 330.0              | 24.4               | 8.6     | 15.8    | 1.8     | 12.0    | 24.0   | Q1            |
| SN74LVCH16374ADGVR | TVSOP                | DGV             | 48   | 2000 | 330.0              | 16.4               | 7.1     | 10.2    | 1.6     | 12.0    | 16.0   | Q1            |
| SN74LVCH16374ADLR  | SSOP                 | DL              | 48   | 1000 | 330.0              | 32.4               | 11.35   | 16.2    | 3.1     | 16.0    | 32.0   | Q1            |
| SN74LVCH16374AZQLR | BGA MICROSTAR JUNIOR | ZQL             | 56   | 1000 | 330.0              | 16.4               | 4.8     | 7.3     | 1.5     | 8.0     | 16.0   | Q1            |

## TAPE AND REEL BOX DIMENSIONS

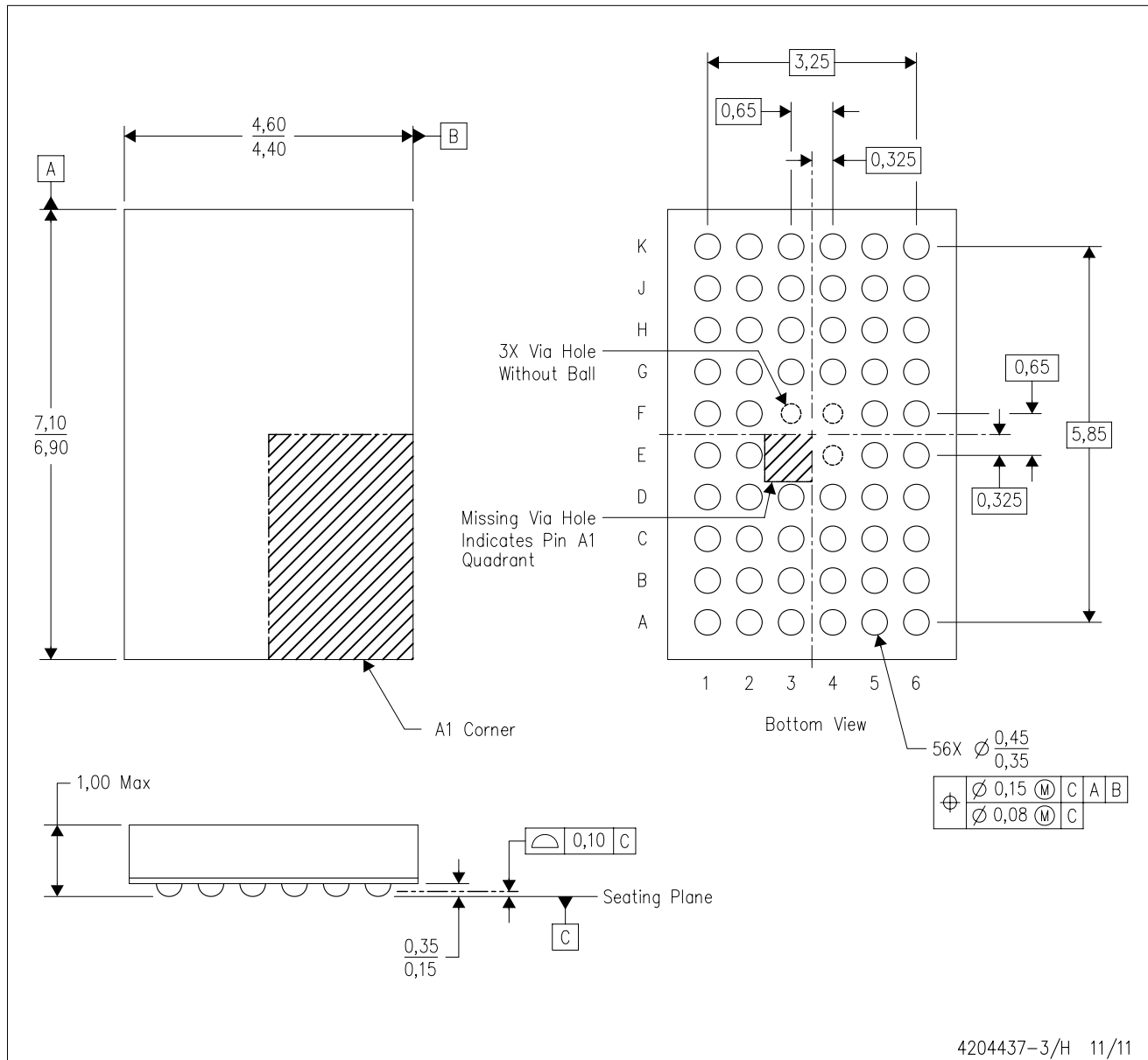


\*All dimensions are nominal

| Device             | Package Type         | Package Drawing | Pins | SPQ  | Length (mm) | Width (mm) | Height (mm) |
|--------------------|----------------------|-----------------|------|------|-------------|------------|-------------|
| SN74LVCH16374ADGGR | TSSOP                | DGG             | 48   | 2000 | 367.0       | 367.0      | 45.0        |
| SN74LVCH16374ADGVR | TVSOP                | DGV             | 48   | 2000 | 367.0       | 367.0      | 38.0        |
| SN74LVCH16374ADLR  | SSOP                 | DL              | 48   | 1000 | 367.0       | 367.0      | 55.0        |
| SN74LVCH16374AZQLR | BGA MICROSTAR JUNIOR | ZQL             | 56   | 1000 | 333.2       | 345.9      | 28.6        |

ZQL (R-PBGA-N56)

PLASTIC BALL GRID ARRAY

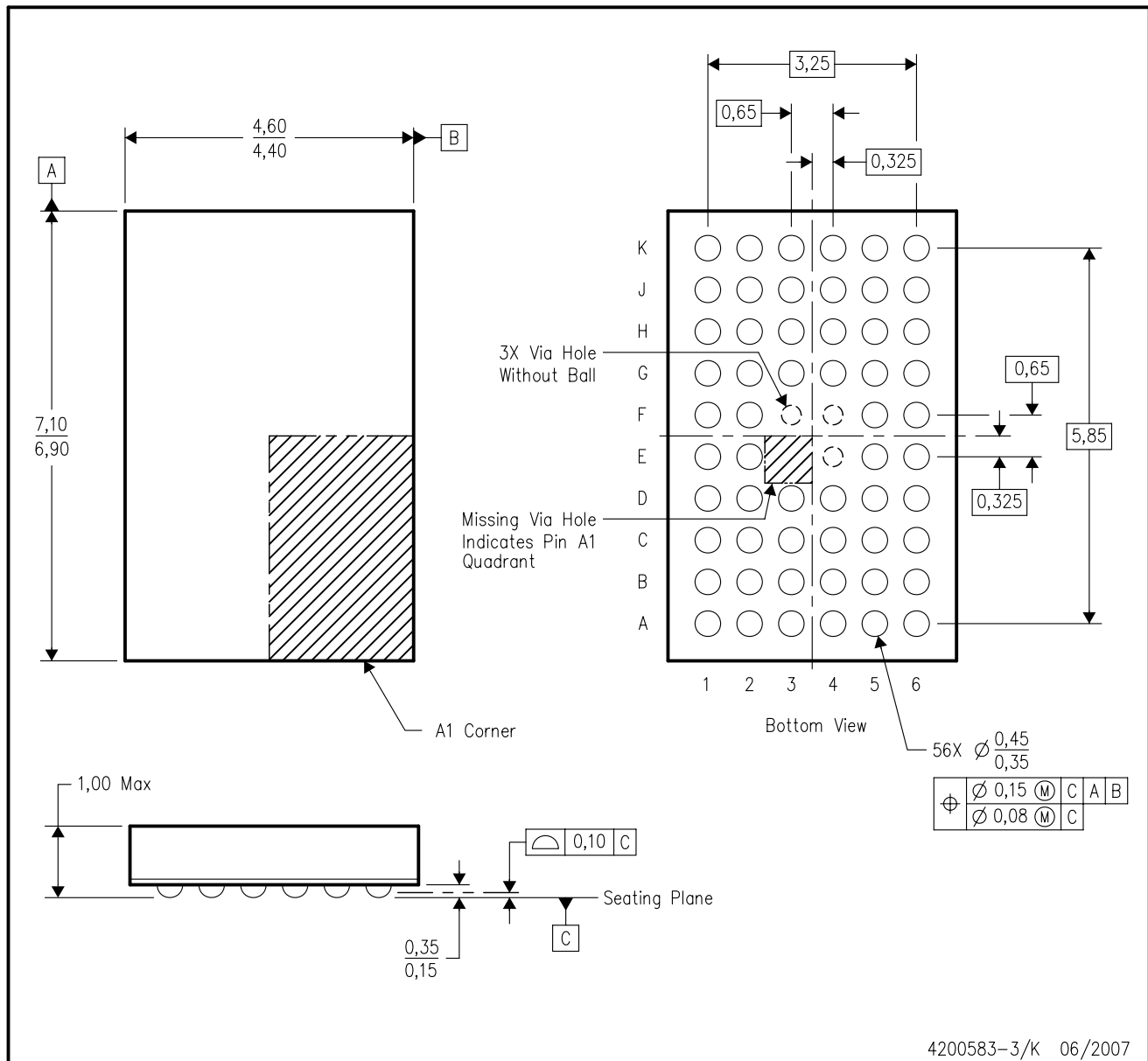


4204437-3/H 11/11

- NOTES:
- A. All linear dimensions are in millimeters. Dimensioning and tolerancing per ASME Y14.5M-1994.
  - B. This drawing is subject to change without notice.
  - C. Falls within JEDEC MO-285 variation BA-2.
  - D. This package is Pb-free. Refer to the 56 GQL package (drawing 4200583) for tin-lead (SnPb).

## GQL (R-PBGA-N56)

## PLASTIC BALL GRID ARRAY



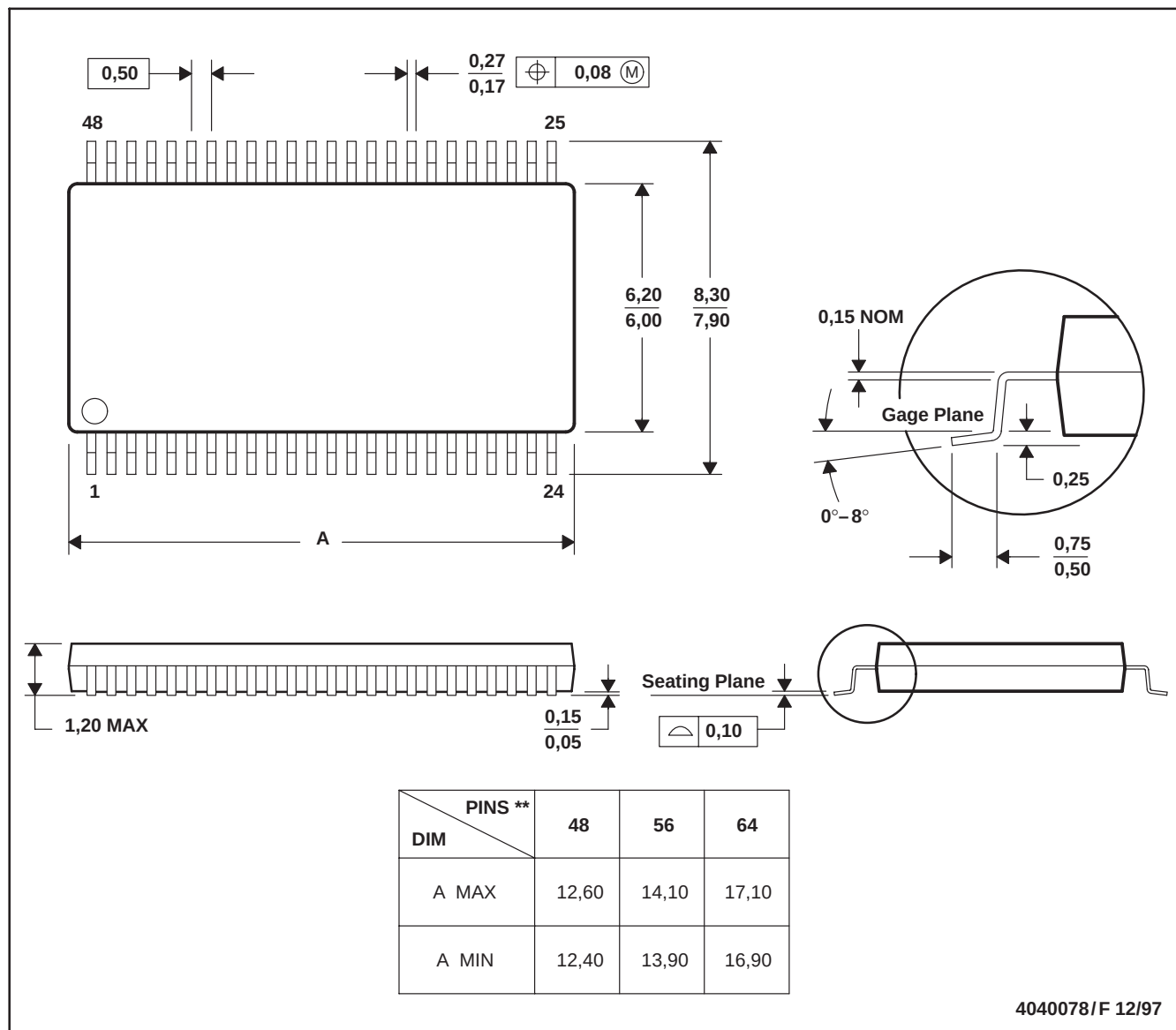
4200583-3/K 06/2007

- NOTES:
- A. All linear dimensions are in millimeters. Dimensioning and tolerancing per ASME Y14.5M-1994.
  - B. This drawing is subject to change without notice.
  - C. Falls within JEDEC MO-285 variation BA-2.
  - D. This package is tin-lead (SnPb). Refer to the 56 ZQL package (drawing 4204437) for lead-free.

## DGG (R-PDSO-G\*\*)

## PLASTIC SMALL-OUTLINE PACKAGE

48 PINS SHOWN



- NOTES: A. All linear dimensions are in millimeters.  
 B. This drawing is subject to change without notice.  
 C. Body dimensions do not include mold protrusion not to exceed 0,15.  
 D. Falls within JEDEC MO-153

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